

BRS 306 ((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or impact\$6 or shock\$7) USPAT; US-PGPUB 2003/09/27 15:48 0
 BRS 269 (((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or impact\$6 or shock\$7)) and (optic\$6 with waveguide) USPAT; US-PGPUB 2003/09/27 15:47 0
 BRS 288 (((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or impact\$6 or shock\$7)) and optic\$6 USPAT; US-PGPUB 2003/09/27 15:47 0
 BRS 312 ((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or impact\$6 or shock\$7 or shak\$7) and optic\$6 USPAT; US-PGPUB 2003/09/27 15:49 0
 BRS 70 ((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or impact\$6 or shock\$7 or shak\$7) and optic\$6 and ((harsh\$4 or impact\$6 or shock\$7 or shak\$7) same (chip\$6 or wafer\$7)) USPAT; US-PGPUB 2003/09/27 15:56 0
 BRS 1 6542659.pn. USPAT; US-PGPUB 2003/09/27 18:50 0
 BRS 75 ((chip\$6 or wafer\$7 or bnch\$6) with waveguide) and substrate and (harsh\$4 or impact\$6 or shock\$7 or shak\$7) and optic\$6 and ((harsh\$4 or impact\$6 or shock\$7 or shak\$7) same (chip\$6 or wafer\$7)) USPAT; US-PGPUB 2003/09/29 11:31 0
 BRS 2 (wafer near2 (foam or resilien\$6)) and (optic\$6 with waveguide) USPAT; US-PGPUB 2003/09/27 17:14 0
 BRS 0 20020159674.URPN. USPAT 2003/09/27 17:30 0
 BRS 1 6498880.pn. USPAT; US-PGPUB 2003/09/27 18:52 0
 BRS 1 5687287.pn. USPAT; US-PGPUB 2003/09/27 18:52 0
 BRS 1 5687267.pn. USPAT; US-PGPUB 2003/09/27 18:54 0
 BRS 1 4178713.pn. USPAT; US-PGPUB 2003/09/29 10:13 0
 BRS 169 Cylinder and cover and module and 385/\$.ccls. USPAT; US-PGPUB 2003/09/29 10:14 0
 BRS 108 Cylinder and cover and module and 385/\$.ccls. USPAT 2003/09/29 10:31 0
 BRS 50 (Cylinder and cover and module and 385/\$.ccls.) and bond\$8 USPAT 2003/09/29 10:14 0
 BRS 1055 module and cover and module and 385/\$.ccls. USPAT 2003/09/29 10:16 0
 BRS 2 mooney.xa. and cover and module and hermet\$8 USPAT 2003/09/29 10:18 0
 BRS 4 ("5124281" | "5500910" | "5764836" | "5835659").PN. USPAT 2003/09/29 10:18 0

BRS	8	mooney.xa. and cover and module	USPAT	2003/09/29 10:19
	0			
BRS	61	mooney.xa. and cover	USPAT	2003/09/29 10:19
	0			
BRS	41	mooney.xa. and cover and michael	USPAT	2003/09/29 10:22
	0			
BRS	10	("4808115" "5091987" "5140659" "5195904" "5302141" "5529513" "5574815" "5641306" "5743763" "5812728").PN.	USPAT	2003/09/29 10:20
	0			
BRS	10	("4738507" "4738508" "5082345" "5212752" "5274729" "5687268" "5838855" "6126325" "6283640" "6335993").PN.	USPAT	2003/09/29 10:21
	0			
BRS	15	mooney.xa. and cover and michael and substrate	USPAT	2003/09/29 10:31
	0			
BRS	2	("5011246" "5390271").PN.	USPAT	2003/09/29 10:23
	0			
BRS	7	("4130343" "4756590" "4897711" "4981334" "5073003" "5155786" "5163113").PN.	USPAT	2003/09/29 10:23
	0			
BRS	51	Cylinder and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)	USPAT	2003/09/29 10:34
	0			
BRS	155	Cylind\$9 and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)	USPAT	2003/09/29 10:37
	0			
BRS	104	(Cylind\$9 and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)) not (Cylinder and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4))	USPAT	2003/09/29 10:35
	0			
BRS	352	cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)	USPAT	2003/09/29 10:37
	0			
BRS	197	(cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)) not ((Cylind\$9 and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)) not (Cylinder and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4))) not (Cylind\$9 and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4))	USPAT	2003/09/29 11:29
	0			
BRS	13	5444804.URPN.	USPAT	2003/09/29 10:39
	0			
BRS	1	5214726.pn.	USPAT	2003/09/29 10:54
	0			
BRS	33	gel with elastic\$6 and 385/\$.ccls.	USPAT	2003/09/29 10:55
	0			
BRS	5	5214726.URPN.	USPAT	2003/09/29 10:58
	0			
BRS	113	chip and (module or package) and damp\$6 and optic\$6 and waveguide	USPAT	2003/09/29 11:30
	0			
BRS	75	((chip\$6 or wafer\$7 or bench\$6) with waveguide) and substrate and (harsh\$4 or impact\$6 or shock\$7 or shak\$7) and optic\$6 and ((harsh\$4 or impact\$6 or shock\$7 or shak\$7) same (chip\$6 or wafer\$7))	USPAT; US-PGPUB	2003/09/29 11:31
	0			

BRS 111 (chip and (module or package) and damp\$6 and optic\$6 and waveguide)
 not (((chip\$6 or wafer\$7 or bench\$6) with waveguide) and substrate and (harsh\$4 or
 impact\$6 or shock\$7 or shak\$7) and optic\$6 and ((harsh\$4 or impact\$6 or shock\$7 or
 shak\$7) same (chip\$6 or wafer\$7))) USPAT; US-PGPUB 2003/09/29 13:03
 0
 BRS 13 5444804.URPN. USPAT 2003/09/29 12:55
 0
 BRS 22 UV with curable with adhes\$6 with elast\$8 USPAT; US-PGPUB
 2003/09/29 13:10 0
 BRS 5 low with modulus with elasticity with impact with protect\$6
 USPAT; US-PGPUB 2003/09/29 13:12 0
 BRS 30 modulus with elasticity with spong\$6USPAT; US-PGPUB 2003/09/29
 13:24 0
 BRS 3 modulus with elasticity with viton USPAT; US-PGPUB 2003/09/29
 13:26 0
 BRS 0 N/m with "Pa" with modulus with elast\$8 USPAT; US-PGPUB
 2003/09/29 13:27 0
 BRS 5 "N/m" with \$6"Pa" with modulus with elast\$8 USPAT; US-PGPUB
 2003/09/29 13:36 0
 BRS 9 "N/m"\$6 with \$6"Pa" with modulus with elast\$8 USPAT; US-PGPUB
 2003/09/29 13:44 0
 BRS 4 ("N/m"\$6 with \$6"Pa" with modulus with elast\$8) not ("N/m" with \$6"Pa"
 with modulus with elast\$8) USPAT; US-PGPUB 2003/09/29 13:39
 0
 BRS 2 "N/m"\$6 with \$6"Pa" with modulus with elast\$8 same "kgf/cm.sup.2"
 USPAT; US-PGPUB 2003/09/29 14:06 0
 BRS 4 5999674.URPN. USPAT 2003/09/29 13:57
 0
 BRS 2 (\$6"Pa" or "kgf/cm.sup.2") with modulus with elast\$8 with UV with
 curableUSPAT; US-PGPUB 2003/09/29 14:08 0
 BRS 7 ("5367591" | "5426714" | "5444804" | "5481632" | "5513290" | "5625730"
 | "5696860").PN. USPAT 2003/09/29 14:24 0
 BRS 18 5426714.URPN. USPAT 2003/09/29 14:43
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